WNSC2D08650T



Silicon Carbide Diode Rev.01 - 21 January 2021

Product data sheet

1. General description

Silicon Carbide Schottky diode in a DFN 8*8 plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		650			V	
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _c ≤ 134 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>		8		A	
T _j	junction temperature		175		°C		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 8 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.5	1.7	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.8	2.2	V
Dynamic	characteristics						
Q _r	recovered charge	I _F = 8 A; dI _F /dt = 500 A/μs; V _R = 400 V; T _j = 25 °C; <u>Fig. 7</u>		-	13	-	nC

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	n.c.	not connected	[]	к_И_А
2	n.c.	not connected	5	K <u>– K</u> A 001aaa020
3	А	anode		
4	А	anode		
5	K	mounting base; connected to cathode	1 2 3 4	

6. Ordering information

Table 3. Ordering information								
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WNSC2D08650T	DFN8*8	WNSC2D08650TJ	Таре	3000	DFN8X8N	25-Dec-2019		

7. Marking

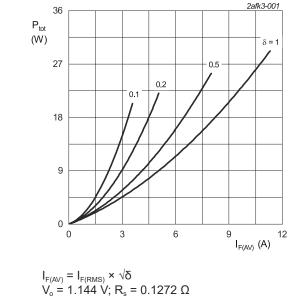
Table 4. Marking codes						
Type number	Marking codes					
WNSC2D08650T	WNSC2D 08650T					

8. Limiting values

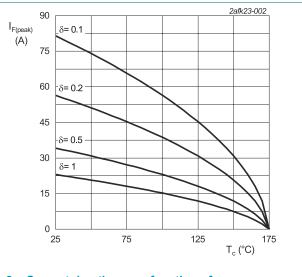
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		650	V
V _{RWM}	crest working reverse voltage		650	V
V _R	reverse voltage	DC	650	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _c ≤ 134 °C; Fig. 1; Fig. 2; Fig. 3	8	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _c ≤ 134 °C; square-wave pulse	16	A
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	48	А
		t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse	385	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	11.5	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C



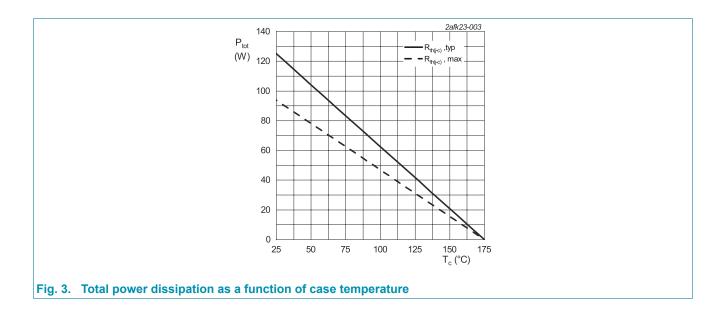
V_o = 1.144 V; R_s = 0.1272 Ω
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values





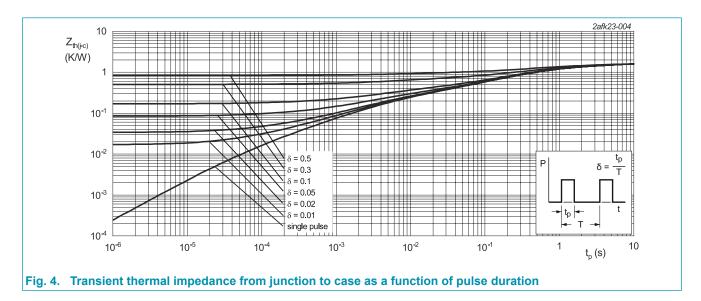
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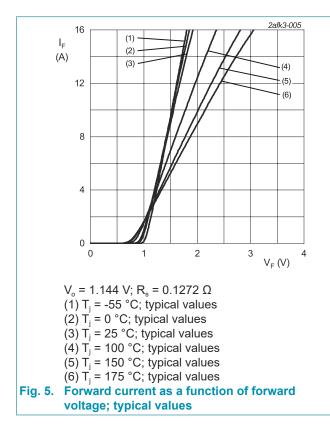
9. Thermal characteristics

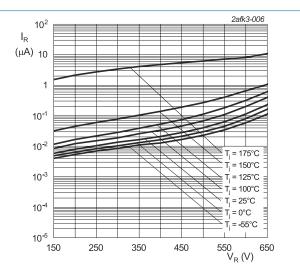
Table 6. Th	ermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	<u>Fig. 4</u>	-	1.2	1.6	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	50	-	K/W



10. Characteristics

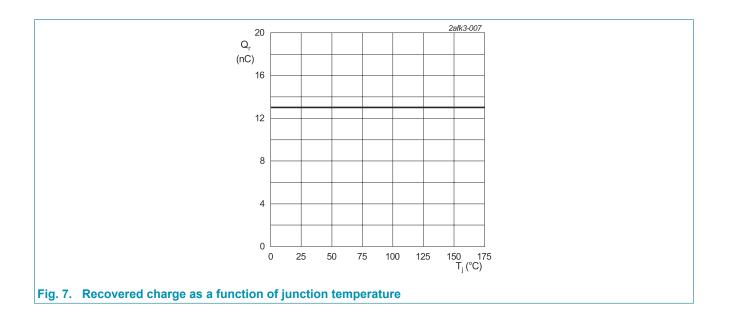
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _F	forward current	I _F = 8 A; T _j = 25 °C; <u>Fig. 5</u>	-	1.5	1.7	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 5</u>	-	1.8	2.2	V
		I _F = 8 A; T _j = 175 °C; <u>Fig. 5</u>	-	2	2.3	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C; <u>Fig. 6</u>	-	0.4	40	μA
		V _R = 650 V; T _j = 175 °C; <u>Fig. 6</u>	-	20	200	μA
Dynamic	characteristics					
Qr	recovered charge	$I_F = 8 \text{ A}; V_R = 400 \text{ V}; \text{ d}_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$	-	13	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	260	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C	-	31	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C	-	27	-	pF
E _{as}	non-repetitive avalanche energy	I _R = 4.9 A; L = 5 mH; T _{j(init)} = 25 °C	60	-	-	mJ



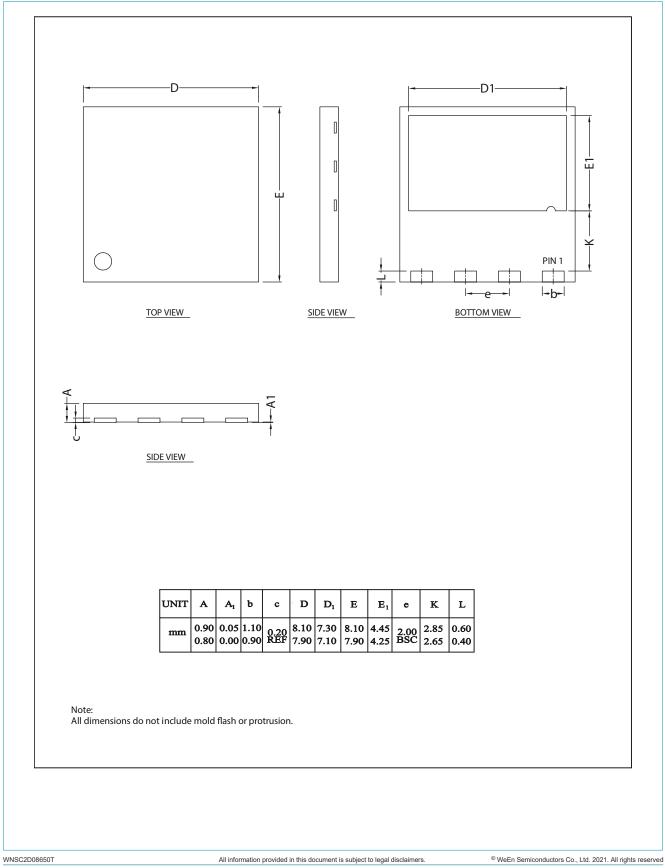




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11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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